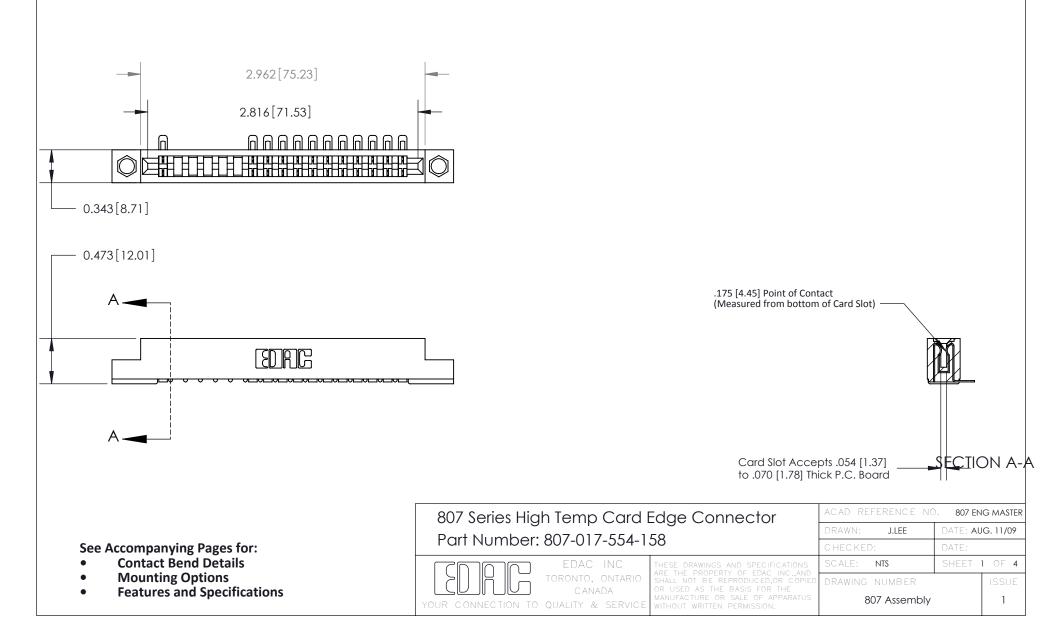
Mounting Option

.468 (11.89) Offset Card Guides

Contact Detail

90 Degree Bend (Code 501 Contacts) .156 [3.96] Contact Spacing x .200 [5.08] Row Spacing THIS IS A C.A.D. GENERATED DRAWING DO NOT MAKE MANUAL REVISIONS TO MASTER.









HIS IS A C.A.D. GENERATED DRAWING ON NOT MAKE MANUAL REVISIONS TO MASTER.

ORIGINAL

Features

- CSA Approved and UL Recognized
- .156 (3.96) Contact Spacing x .200 (5.08) Row Spacing
- Accepts .062 (1.57) Nominal Thickness P.C. Board
- Low Profile Insulator Body .473 (12.01), with Card Guides
- Contact Termination Options include P.C. Tail, Wire Hole, Wire Wrap, 90 Degree & Extender Board Bends
- Single or Dual Row Configurations
- Large Variety of Mounting Options
- Pre-assembled Card Guides Available
- Accepts Between Contact and In-Contact Polarizing Keys

Specifications

- Insulator Material: DAP
- Contact Material: Copper, Nickel, Tin Alloy CA-725
- Contact Plating: Gold on the Mating Area, Tin on the Contact Tails, Nickel Underplate
- Current Rating: 5 Amperes Continuous
- Contact Resistance: 10 Milliohms Maximum
- Dielectric Withstanding Voltage: 1800 V AC rms at Sea Level Between Adjacent Contacts
- Insulation Resistance: 5000 Megohms Minimum
- Operating Temperature: -65 to +165 °C
- Insertion Force: 16 oz (4.45 N) Maximum per Contact Pair when Tested with a .070 (1.78) Thick Gauge
- Withdrawal Force: 1 oz (0.28 N) Minimum per Contact Pair when Tested with a .054 (1.37) Thick Gauge

807 Series High Temp Card Edge Connector Features and Specifications		ACAD REFERENCE NO. 807 ENG MASTER			
		DRAWN:	J.LEE	DATE: AUG. 11/09	
		CHECKED:		DATE:	
TORONTO, ONTARIO CANADA	THESE DRAWINGS AND SPECIFICATIONS ARE THE PROPERTY OF EDAC INC.,AND SHALL NOT BE REPRODUCED,OR COPIED OR USED AS THE BASIS FOR THE MANUFACTURE OR SALE OF APPARATUS WITHOUT WRITTEN PERMISSION.	SCALE:	NTS	SHEET 4	4 OF 4
		DRAWING	NUMBER		ISSUE
		8	07 Assembly		1